

APPLICATION DATA SHEET

APPLICATION INFORMATION

Application Type:: REGULAR
Subject Matter:: UTILITY
CD-ROM or CD-R?: NONE
Title:: SEMICONDUCTOR POWER MODULE
Attorney Docket Number:: 242921US2
Total Drawing Sheets:: 4

INVENTOR INFORMATION

Applicant Authority Type:: INVENTOR
Primary Citizenship Country:: Japan
Status:: FULL CAPACITY
Given Name:: Junji
Family Name:: YAMADA
City of Residence:: Tokyo
Country of Residence:: Japan
Street of Mailing Address:: c/o Mitsubishi Denki Kabushiki Kaisha, 2-3, Marunouchi 2-chome, Chiyoda-ku,
City of Mailing Address:: Tokyo
Country of Mailing Address:: Japan
Postal or Zip Code of Mailing Address:: 100-8310

Applicant Authority Type:: INVENTOR
Primary Citizenship Country:: Japan
Status:: FULL CAPACITY
Given Name:: Seiji
Family Name:: SAIKI
City of Residence:: Fukuoka
Country of Residence:: Japan
Street of Mailing Address:: c/o Fukuryo Semi-con Engineering Corporation, 1-1, Imajuku-higashi 1-chome, Nishi-ku,
City of Mailing Address:: Fukuoka-shi
State or Province of Mailing Address:: Fukuoka
Country of Mailing Address:: Japan
Postal or Zip Code of Mailing Address:: 819-0161

Correspondence Customer Number:: 22850

REPRESENTATIVE INFORMATION

Representative Customer Number:: 22850

FOREIGN PRIORITY INFORMATION

Application Number:	Country::	Filing Date::	Priority Claimed::
2002-360730	Japan	12/12/02	YES

ASSIGNMENT INFORMATION

Assignee Name:: Mitsubishi Denki Kabushiki Kaisha
Street of Mailing Address:: 2-3, Marunouchi 2-chome
City of Mailing Address:: Chiyoda-ku
State or Province of Mailing Address:: Tokyo
Country of Mailing Address:: Japan
Postal or Zip Code of Mailing Address:: 100-8310